

# TrenchMOS™ transistor

## Standard level FET

BUK7675-55

### GENERAL DESCRIPTION

N-channel enhancement mode standard level field-effect power transistor in a plastic envelope suitable for surface mounting. Using 'trench' technology the device features very low on-state resistance and has integral zener diodes giving ESD protection up to 2kV. It is intended for use in automotive and general purpose switching applications.

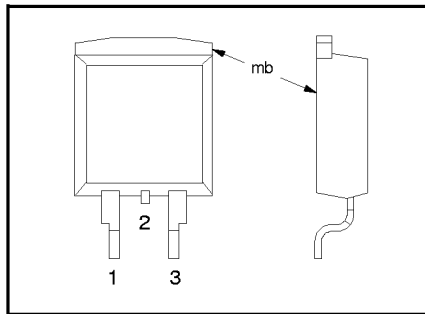
### QUICK REFERENCE DATA

| SYMBOL       | PARAMETER                                               | MAX. | UNIT |
|--------------|---------------------------------------------------------|------|------|
| $V_{DS}$     | Drain-source voltage                                    | 55   | V    |
| $I_D$        | Drain current (DC)                                      | 19.7 | A    |
| $P_{tot}$    | Total power dissipation                                 | 61   | W    |
| $T_j$        | Junction temperature                                    | 175  | °C   |
| $R_{DS(ON)}$ | Drain-source on-state resistance $V_{GS} = 10\text{ V}$ | 75   | mΩ   |

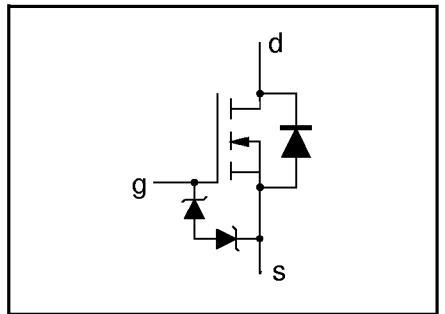
### PINNING - SOT404

| PIN | DESCRIPTION |
|-----|-------------|
| 1   | gate        |
| 2   | drain       |
| 3   | source      |
| mb  | drain       |

### PIN CONFIGURATION



### SYMBOL



### LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| SYMBOL         | PARAMETER                        | CONDITIONS                           | MIN. | MAX. | UNIT |
|----------------|----------------------------------|--------------------------------------|------|------|------|
| $V_{DS}$       | Drain-source voltage             | -                                    | -    | 55   | V    |
| $V_{DGR}$      | Drain-gate voltage               | $R_{GS} = 20\text{ k}\Omega$         | -    | 55   | V    |
| $\pm V_{GS}$   | Gate-source voltage              | -                                    | -    | 16   | V    |
| $I_D$          | Drain current (DC)               | $T_{mb} = 25\text{ }^\circ\text{C}$  | -    | 19.7 | A    |
| $I_D$          | Drain current (DC)               | $T_{mb} = 100\text{ }^\circ\text{C}$ | -    | 13.9 | A    |
| $I_{DM}$       | Drain current (pulse peak value) | $T_{mb} = 25\text{ }^\circ\text{C}$  | -    | 79   | A    |
| $P_{tot}$      | Total power dissipation          | $T_{mb} = 25\text{ }^\circ\text{C}$  | -    | 61   | W    |
| $T_{stg}, T_j$ | Storage & operating temperature  | -                                    | -55  | 175  | °C   |

### ESD LIMITING VALUE

| SYMBOL | PARAMETER                                           | CONDITIONS                        | MIN. | MAX. | UNIT |
|--------|-----------------------------------------------------|-----------------------------------|------|------|------|
| $V_C$  | Electrostatic discharge capacitor voltage, all pins | Human body model (100 pF, 1.5 kΩ) | -    | 2    | kV   |

### THERMAL RESISTANCES

| SYMBOL         | PARAMETER                                    | CONDITIONS                   | TYP. | MAX. | UNIT |
|----------------|----------------------------------------------|------------------------------|------|------|------|
| $R_{th\ j-mb}$ | Thermal resistance junction to mounting base | -                            | -    | 2.46 | K/W  |
| $R_{th\ j-a}$  | Thermal resistance junction to ambient       | Minimum footprint, FR4 board | 50   | -    | K/W  |

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### STATIC CHARACTERISTICS

 $T_j = 25^\circ\text{C}$  unless otherwise specified

| SYMBOL            | PARAMETER                        | CONDITIONS                                                               | MIN.       | TYP.     | MAX.     | UNIT             |
|-------------------|----------------------------------|--------------------------------------------------------------------------|------------|----------|----------|------------------|
| $V_{(BR)DSS}$     | Drain-source breakdown voltage   | $V_{GS} = 0\text{ V}; I_D = 0.25\text{ mA}; T_j = -55^\circ\text{C}$     | 55<br>50   | -<br>-   | -<br>-   | V<br>V           |
| $V_{GS(TO)}$      | Gate threshold voltage           | $V_{DS} = V_{GS}; I_D = 1\text{ mA}; T_j = 175^\circ\text{C}$            | 2.0<br>1.0 | 3.0<br>- | 4.0<br>- | V<br>V           |
| $I_{DSS}$         | Zero gate voltage drain current  | $V_{DS} = 55\text{ V}; V_{GS} = 0\text{ V}; T_j = -55^\circ\text{C}$     | -          | -        | 4.4      | $\mu\text{A}$    |
| $I_{GSS}$         | Gate source leakage current      | $V_{GS} = \pm 10\text{ V}; V_{DS} = 0\text{ V}; T_j = 175^\circ\text{C}$ | -          | 0.05     | 10       | $\mu\text{A}$    |
| $\pm V_{(BR)GSS}$ | Gate source breakdown voltage    | $I_G = \pm 1\text{ mA}; T_j = 175^\circ\text{C}$                         | -          | -        | 500      | $\mu\text{A}$    |
| $R_{DS(ON)}$      | Drain-source on-state resistance | $V_{GS} = 10\text{ V}; I_D = 10\text{ A}; T_j = 175^\circ\text{C}$       | -          | 0.04     | 1        | $\mu\text{A}$    |
|                   |                                  |                                                                          | -          | -        | 20       | $\mu\text{A}$    |
|                   |                                  |                                                                          | 16         | -        | -        | V                |
|                   |                                  |                                                                          | -          | 60       | 75       | $\text{m}\Omega$ |
|                   |                                  |                                                                          | -          | -        | 157      | $\text{m}\Omega$ |

### DYNAMIC CHARACTERISTICS

 $T_{mb} = 25^\circ\text{C}$  unless otherwise specified

| SYMBOL     | PARAMETER                  | CONDITIONS                                                                        | MIN. | TYP. | MAX. | UNIT |
|------------|----------------------------|-----------------------------------------------------------------------------------|------|------|------|------|
| $g_{fs}$   | Forward transconductance   | $V_{DS} = 25\text{ V}; I_D = 10\text{ A}$                                         | 1    | -    | -    | S    |
| $C_{iss}$  | Input capacitance          | $V_{GS} = 0\text{ V}; V_{DS} = 25\text{ V}; f = 1\text{ MHz}$                     | -    | 365  | 500  | pF   |
| $C_{oss}$  | Output capacitance         |                                                                                   | -    | 110  | 135  | pF   |
| $C_{rss}$  | Feedback capacitance       |                                                                                   | -    | 60   | 85   | pF   |
| $t_{don}$  | Turn-on delay time         | $V_{DD} = 30\text{ V}; I_D = 10\text{ A}; V_{GS} = 10\text{ V}; R_G = 10\ \Omega$ | -    | 9    | 14   | ns   |
| $t_r$      | Turn-on rise time          |                                                                                   | -    | 16   | 21   | ns   |
| $t_{doff}$ | Turn-off delay time        | Resistive load                                                                    | -    | 14   | 25   | ns   |
| $t_f$      | Turn-off fall time         |                                                                                   | -    | 13   | 20   | ns   |
| $L_d$      | Internal drain inductance  | Measured from upper edge of drain tab to centre of die                            | -    | 2.5  | -    | nH   |
| $L_s$      | Internal source inductance | Measured from source lead soldering point to source bond pad                      | -    | 7.5  | -    | nH   |

### REVERSE DIODE LIMITING VALUES AND CHARACTERISTICS

 $T_j = 25^\circ\text{C}$  unless otherwise specified

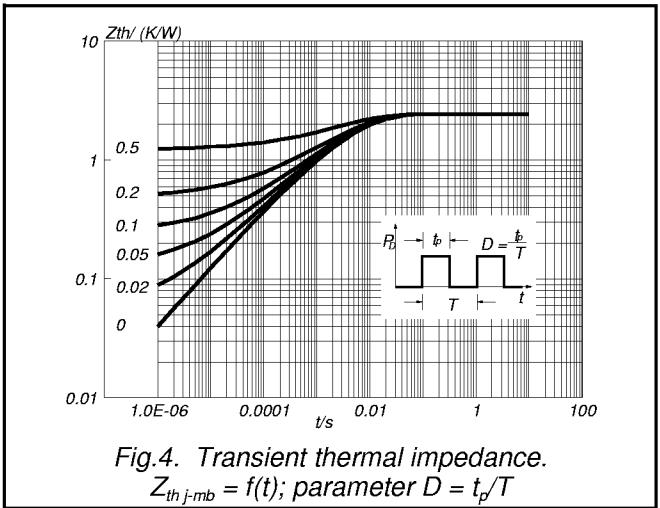
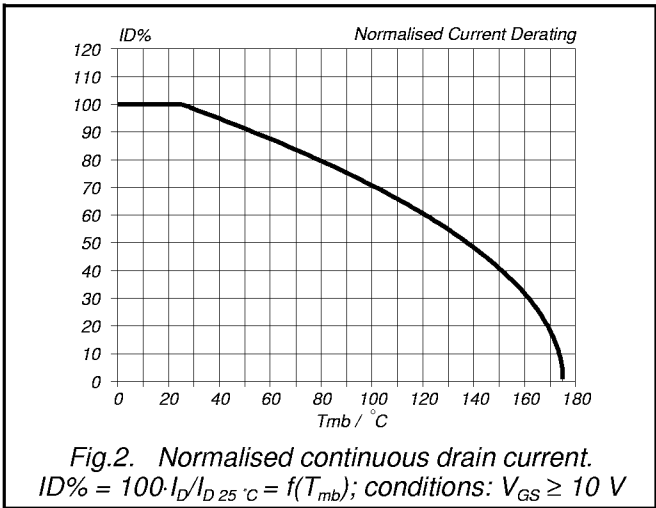
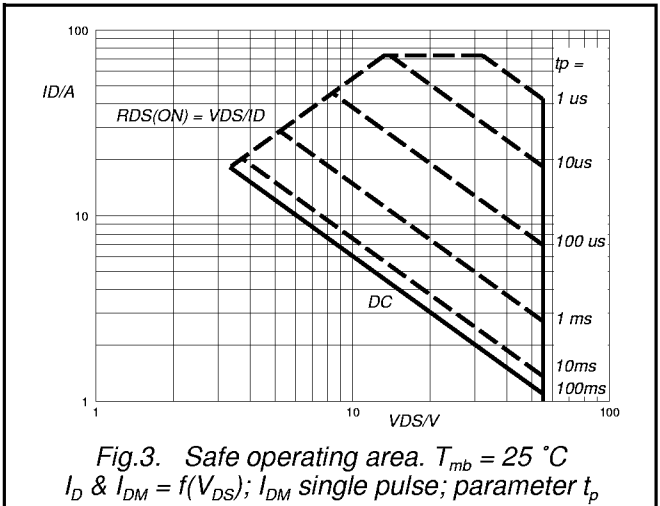
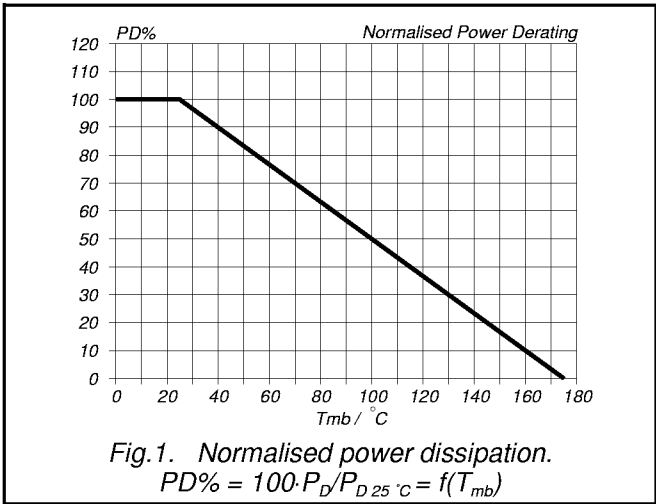
| SYMBOL    | PARAMETER                        | CONDITIONS                                                                                           | MIN. | TYP. | MAX. | UNIT          |
|-----------|----------------------------------|------------------------------------------------------------------------------------------------------|------|------|------|---------------|
| $I_{DR}$  | Continuous reverse drain current |                                                                                                      | -    | -    | 19.7 | A             |
| $I_{DRM}$ | Pulsed reverse drain current     |                                                                                                      | -    | -    | 79   | A             |
| $V_{SD}$  | Diode forward voltage            | $I_F = 19.7\text{ A}; V_{GS} = 0\text{ V}$                                                           | -    | 0.95 | 1.2  | V             |
| $t_{rr}$  | Reverse recovery time            | $I_F = 19.7\text{ A}; -dI_F/dt = 100\text{ A}/\mu\text{s}; V_{GS} = -10\text{ V}; V_R = 30\text{ V}$ | -    | 32   | -    | ns            |
| $Q_{rr}$  | Reverse recovery charge          |                                                                                                      | -    | 0.12 | -    | $\mu\text{C}$ |

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AVALANCHE LIMITING VALUE

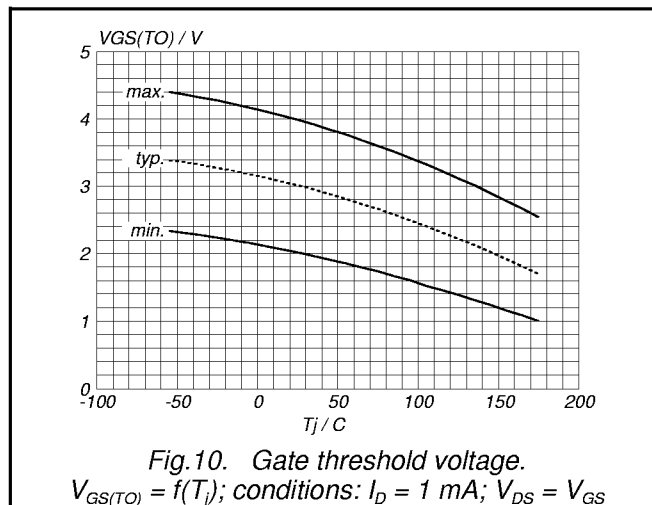
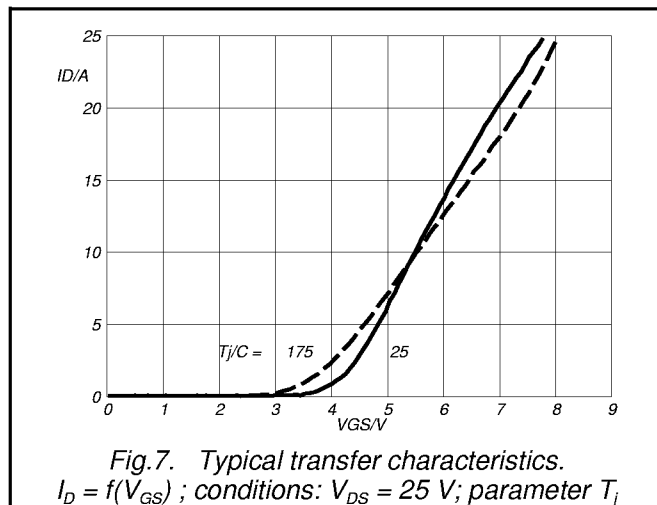
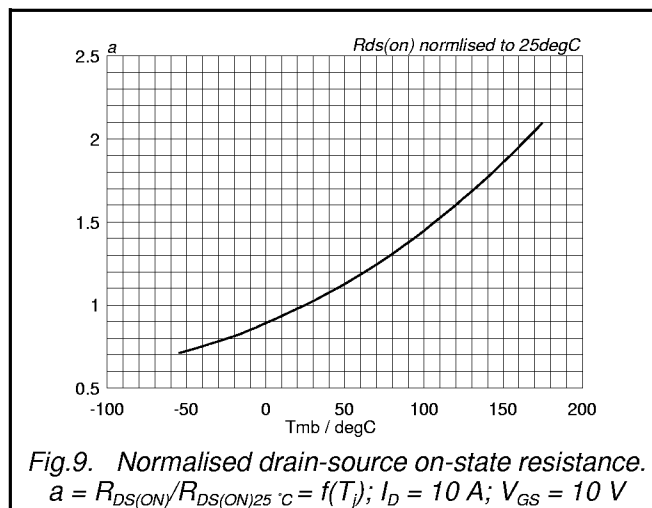
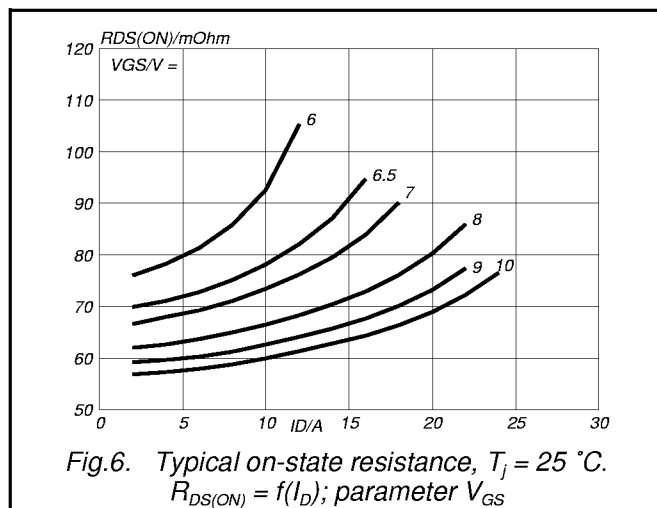
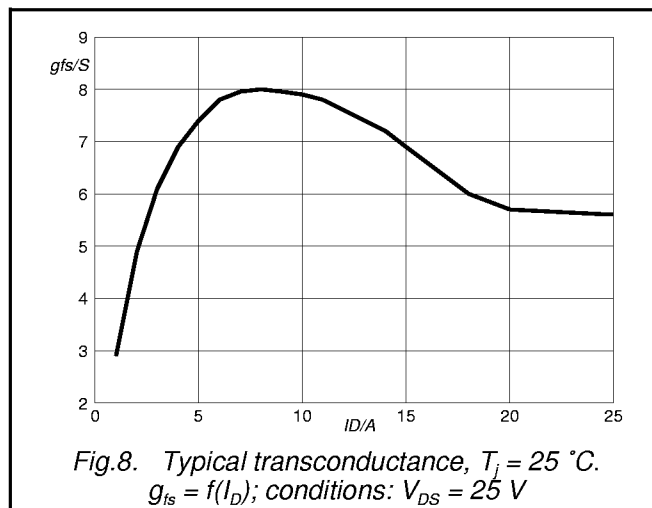
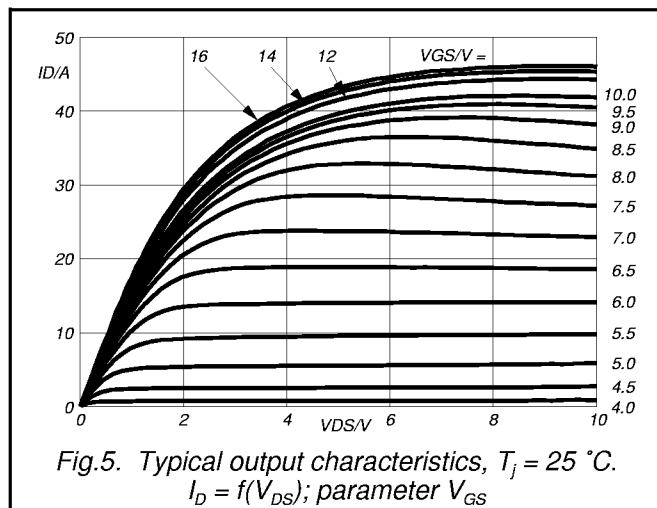
| SYMBOL    | PARAMETER                                                       | CONDITIONS                                                                                                                                      | MIN. | TYP. | MAX. | UNIT |
|-----------|-----------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------|------|------|------|------|
| $W_{DSS}$ | Drain-source non-repetitive unclamped inductive turn-off energy | $I_D = 10\text{ A}$ ; $V_{DD} \leq 25\text{ V}$ ;<br>$V_{GS} = 10\text{ V}$ ; $R_{GS} = 50\text{ }\Omega$ ; $T_{mb} = 25\text{ }^\circ\text{C}$ | -    | -    | 30   | mJ   |



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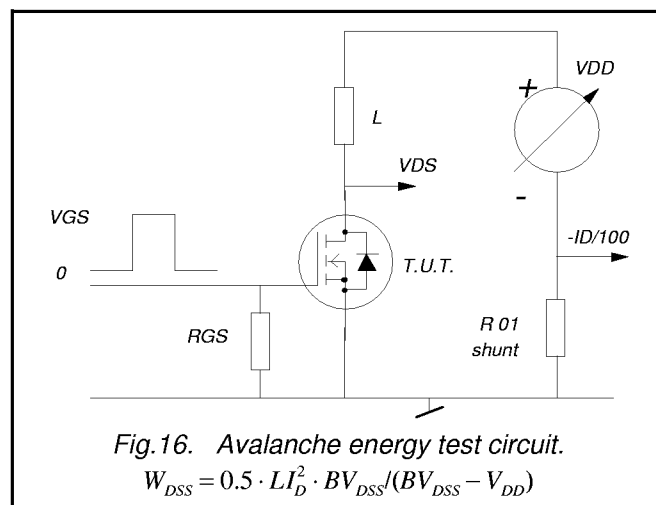
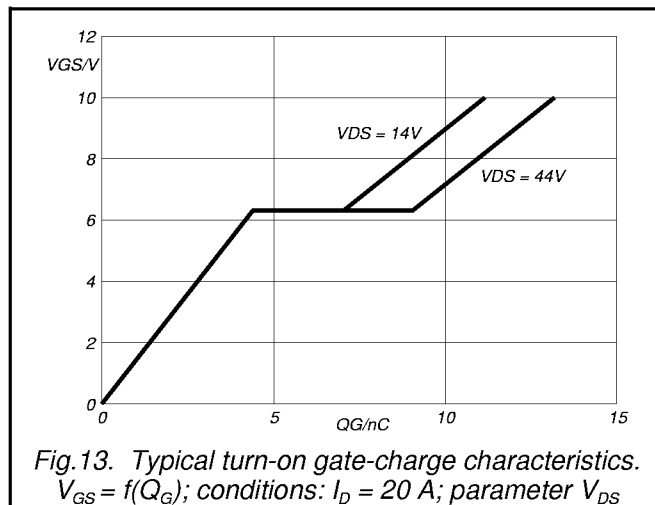
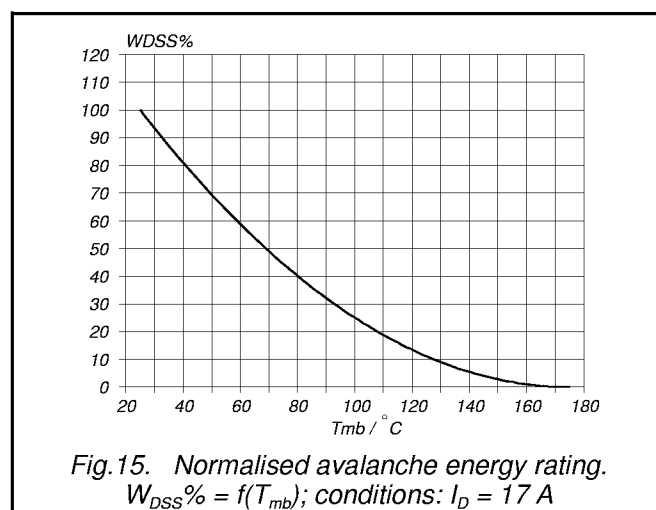
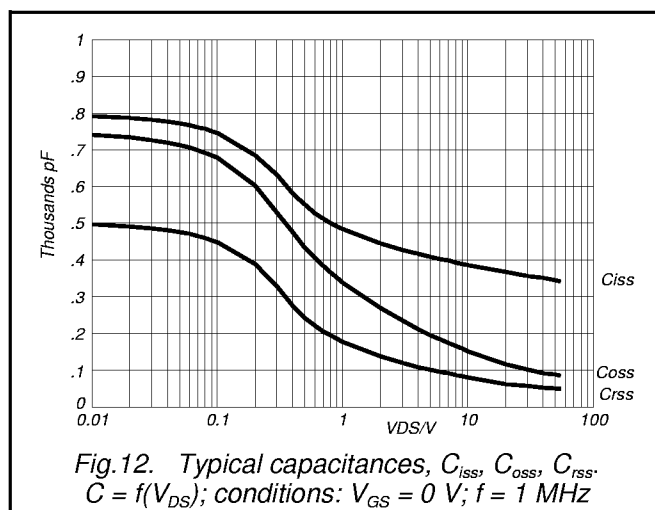
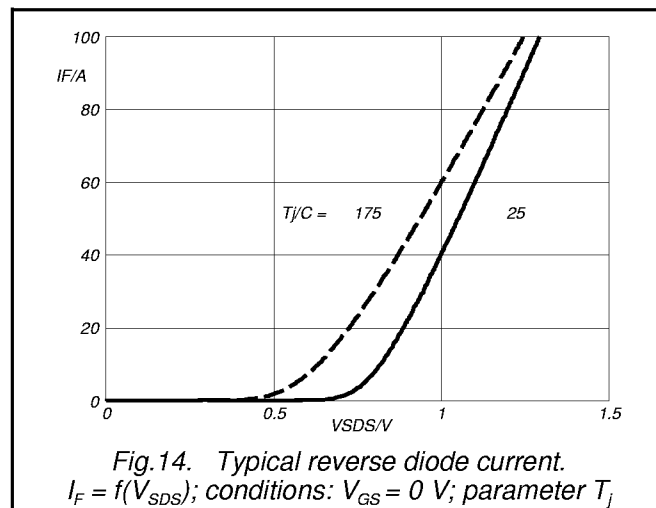
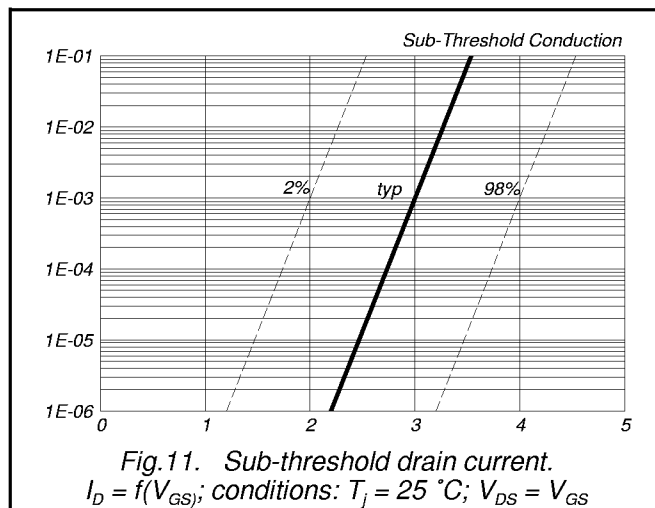
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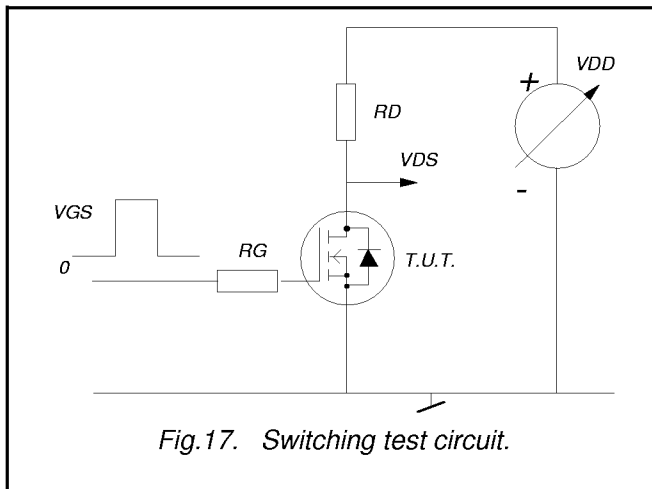


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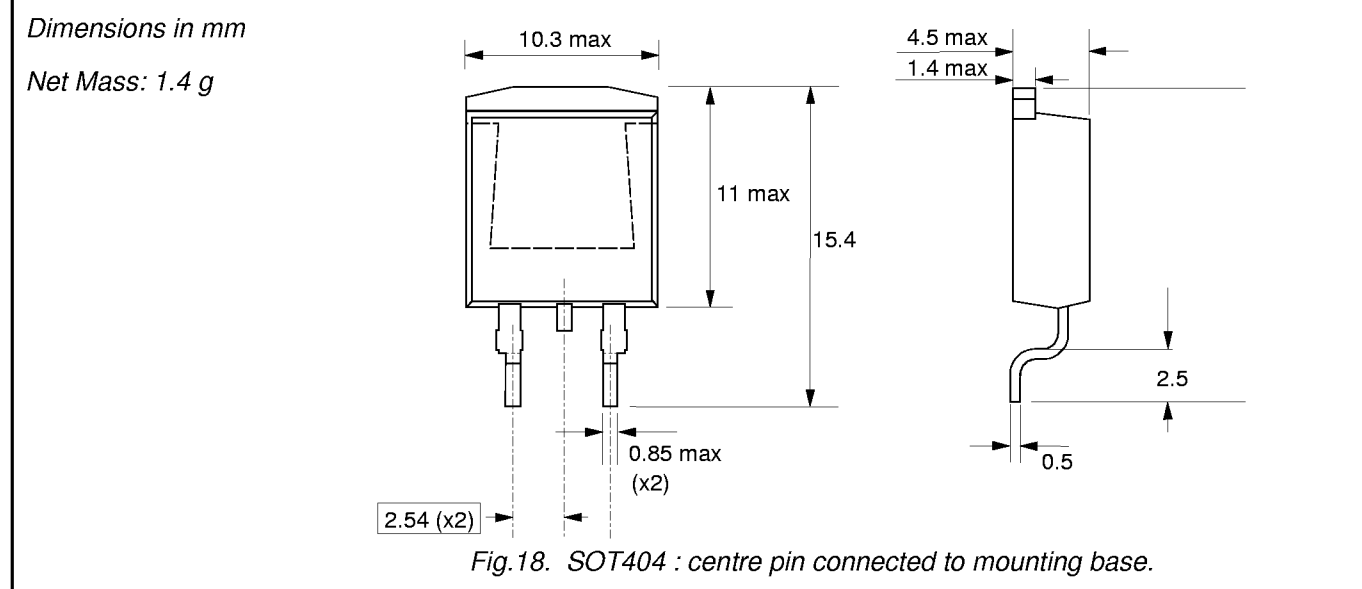


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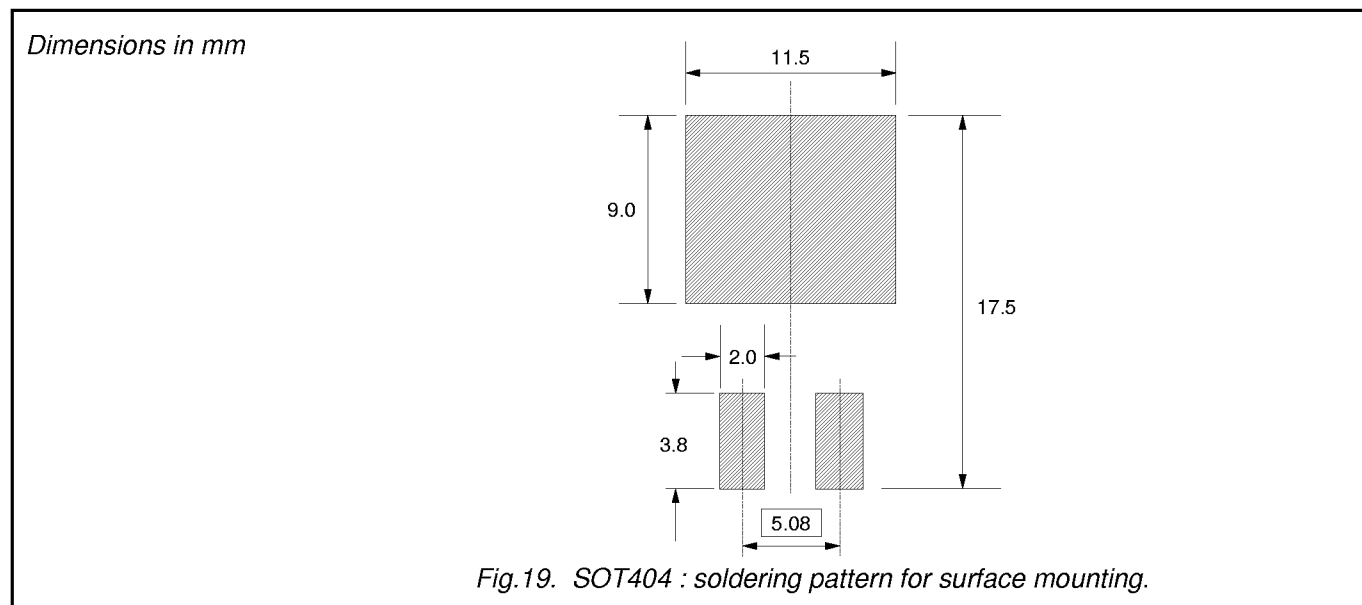
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### MECHANICAL DATA



### MOUNTING INSTRUCTIONS



#### Notes

1. Observe the general handling precautions for electrostatic-discharge sensitive devices (ESDs) to prevent damage to MOS gate oxide.
2. Epoxy meets UL94 V0 at 1/8".